

SPECIFICATION SHEET

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SPECIFICATION SHEET NO.	N0626-MBSMB6S000S160
DATE	June 26, 2021
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REVISION	AO
DESCRIPITION	CAAD Circle Disease Class Descinate d Daides Destifica AADC Caries
DESCRIPTION	SMD Single Phase Glass Passivated Bridge Rectifier, MBS Series,
	MB6S Type 4 Pins,
	Reverse Voltage 600V Max. Forward Current 1.0A Max.
	Operating Temp. Range -55°C ~+150°C,
	Package in Tape/Reel, 3000pcs/Reel
	RoHS/RoHS III compliant
CUSTOMER	
CUSTOMER PART NUMBER	
CROSS REF. PART NUMBER	
CROSS REITTART NORIBER	
ORIGINAL PART NUMBER	MDD MB6S
PART CODE	MBSMB6S000S160

VENDOR APPROVE

Issued/Checked/Approved

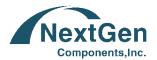






DATE: June 26, 2021

CUSTOMER APPROVE	
DATE:	



SMD BRIDGE RECTIFER MBS SERIES

MAIN FEATURE





- Reliable low cost construction utilizing molded plastic technique
- Small size simple installation
- · High surge current capability
- High temperature soldering guaranteed. 260 °C/10 seconds, at 5 lbs (2.3kg) tension

APPLICATION

• For printed circuit board

PART CODE GUIDE

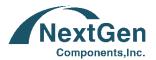
RFQ
Request For Quotation

MBS	MB6S000	S	160
1	2	3	4

- 1) MBS: SMD Single Phase Glass Passivated Bridge Rectifier, 4 pins, MBS Series
- 2) MB6S000: Type code for original part number MB6S
- 3) S: Package code, Tape/reel, 3000pcs/reel.
- 4) 160: Specification code for Reverse Voltage 600V Max. Forward Current 1.0A Max.

MORE ITEMS AVAILABLE

MBSMB1S000S110	MBSMB2S000S120	MBSMB4S000S140	MBSMB6S000S160	MBSMB8S000S180
MBSMB8S000S180	MBSMB10S00S10A			



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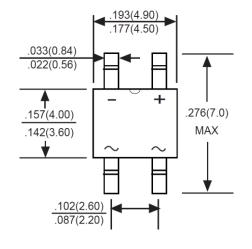
DIMENSION (Unit: Inch/mm)

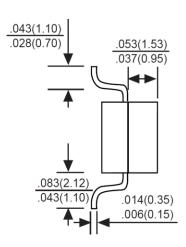
Image for reference

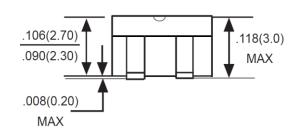


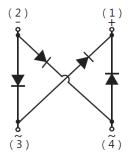
Marking: MB6S



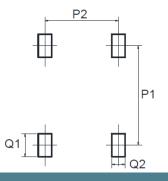








Recommend Pad Layout



Symbol	Min. (Inch)	Min. (mm)
P1	0.236	6.00
P2	0.094	2.40
Q1	0.072	1.84
Q2	0.047	1.20



SMD BRIDGE RECTIFER MBS SERIES

MECHANICAL DATA

Case	Terminals	Polarity	Mounting Position	Weight per piece
JEDEC MBS molded plastic body	Solder plated, Solderable per MIL-STD-750, Method 2026	Polarity symbol marking on case	Any	0.0035 Ounce, 0.1080 grams

MAX. RATING & CHARACTERISTICS

Parameter		SYMBOLS		VALUE		UNITS
			Min.	Typical	Max.	
Repetitive peak reverse voltage		V RRM			600	Volts
RMS voltage		V RMS			700	Volts
DC blocking voltage		V DC			600	Volts
Average forward output rectified cur	rent	l av			1.0	А
at Tc= 30°C						
On glass-epoxy PCB						
On aluminum substrate						
Peak forward surge current 8.3ms sin	gle half	I FSM		35		Α
sine-wave superimposed on rated loa	nd					
(JEDEC Method)						
Instantaneous forward voltage at 0.4	A	V F			1.1	Volts
DC reverse current at rated DC	TA=25°C	l R			5.0	μΑ
blocking voltage	TA=125°C				500	μΑ
Junction capacitance	Junction capacitance			13		pF
Thermal resistance (Note 4)		R QJA		70		°C/W
Operating junction temperature range		TJ	-55		+150	
Storage temperature range		T sтg	-55		+150	°C

Note

- 1. Ratings at 25 C ambient temperature unless otherwise specified. Single phase half-wave 60Hz, resistive or inductive load, for capacitive load current derate by 20%.
- 2. On glass epoxy PCB mounted on 0.05*0.05" (1.3*1.3mm) pads
- 3. On aluminum substrate PCB with on area of 0.8*0.8" (20*20mm) mounted on 0.05*0.05" (1.3*1.3mm) solder pads
- 4. Measured at 1.0MHz and applied reverse voltage of 4.0Voltage



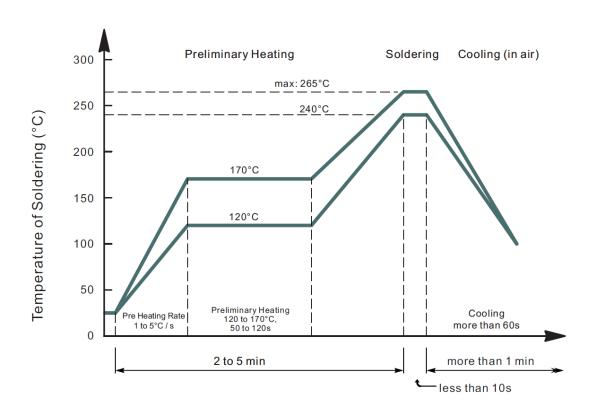
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RELIABILITY

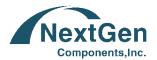
Number	Experiment Items	Experiment Method And Conditions	Reference Documents
1	Solder Resistance Test	Test 260°C± 5°C for 10 ± 2 sec. Immerse body into solder 1/16" ± 1/32"	MIL-STD-750D METHOD-2031.2
2	Solderability Test	230°C ±5°C for 5 sec.	MIL-STD-750D METHOD-2026.1 0
3	Pull Test	1 kg in axial lead direction for 10 sec.	MIL-STD-750D METHOD-2036.4
4	Bend Test	0.5Kg Weight Applied To Each Lead, Bending Arcs 90 °C ± 5 °C For 3 Times	MIL-STD-750D METHOD-2036.4
5	High Temperature Reverse Bias Test	TA=100°C for 1000 Hours at VR=80% Rated VR	MIL-STD-750D METHOD-1038.4
6	Forward Operation Life Test	TA=25°C Rated Average Rectified Current	MIL-STD-750D METHOD-1027.3
7	Intermittent Operation Life Test	On state: 5 min with rated IRMS Power Off state: 5 min with Cool Forced Air. On and off for 1000 cycles.	MIL-STD-750D METHOD-1036.3
8	Pressure Cooker Test	15 PSIG, Ta=121°C, 4 hours	MIL-S-19500 APPENOIXC
9	Temperature Cycling Test	-55°C~+125°C; 30 Minutes For Dwelled Time 5 minutes for transferred time. Total: 10 cycles.	MIL-STD-750D METHOD-1051.7
10	Thermal Shock Test	0°C for 5 minutes., 100°C for 5minutes, Total: 10 cycles	MIL-STD-750D METHOD-1056.7
11	Forward Surge Test	8.3ms Single Sale Sine-wave One Surge.	MIL-STD-750D METHOD-4066.4
12	Humidity Test	TA=65°C, RH=98% for 1000 hours.	MIL-STD-750D METHOD-1021.3
13	High Temperature Storage life Test	150°C for 1000 Hours	MIL-STD-750D METHOD-1031.5

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SUGGESTED REFLOW PROFILE (For Reference Only)

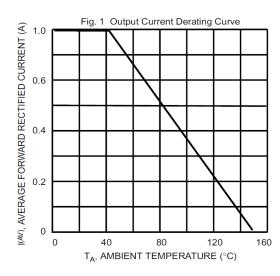


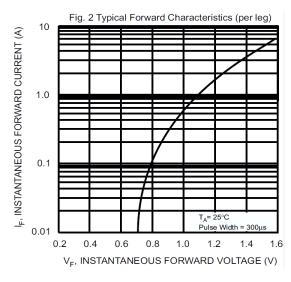
- Recommended peak temperature is over 245°C, If peak temperature is below 245 °C, you may adjust the
 following parameters; time length of peak temperature (longer), time length of soldering (longer), thickness of
 solder paste (thicker)
- · Welding shall not exceed 2 times
- Remark: lead free solder paste (96.5 sn/3.0 Ag/0.5Cu)

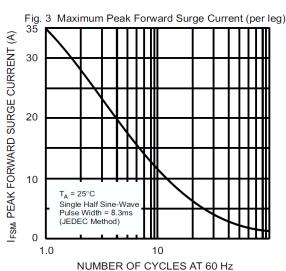


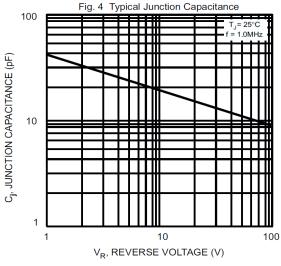
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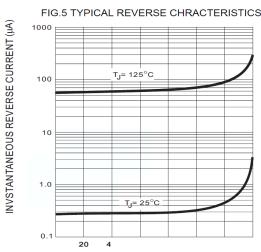
RATINGS AND CHARACTERISTIC CURVES (For Reference Only)



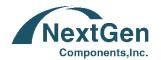








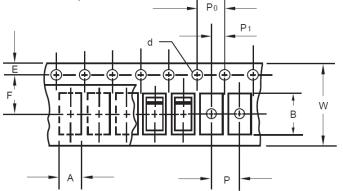
PERCENT OF RATED PEAK INVERSE VOLTGE (V)

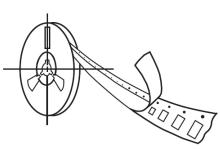


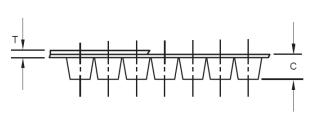
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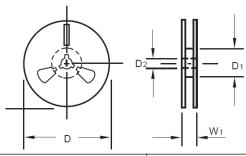
TAPE/REEL (Unit: mm)

All Devices are packed in accordance with EIA standard RS-481-A and specifications.









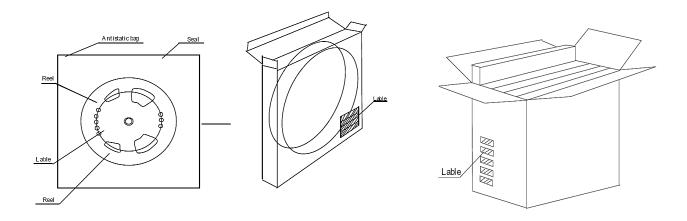
Item	Symbol	Tolerance	MBS
Carrier width	А	0.1	2.8
Carrier Length	В	0.1	5.33
Carrier Depth	С	0.1	2.36
Sprocket hole	d	0.05	1.50
13"Reel outside diameter	D	2.0	330.00
13"Reel inner diameter	D1	Min.	50.00
7"Reel outside diameter	D	-	-
7"Reel inner diameter	D1	-	-
Feed hole diameter	D2	0.5	13.00
Sprocket hole position	E	0.1	1.75
Punch hole position	F	0.1	5.50
Punch hole pitch	Р	0.1	4.00
Sprocket hole pitch	P0	0.1	4.00
Embossment center	P1	0.1	2.0
Overall tape thickness	Т	0.1	0.28
Tape width	W	0.3	12.00
Reel width	W1	1.0	18.0



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PACKAGE

Case Code	Reel Size	MPQ (pcs)	Component Spacing (mm)	Qty. Per Box (pcs)	Inner Box L*W*H (mm)	Reel Size (mm)	Carton size L*W*H (mm)	Qty. Per Carton (pcs)	G. W (kg)
MBS	13"	3,000	-	6,000	190*190*41	330	380*380*380	48,000	12.0



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